

AMENDMENTS TO THE CLAIMS

Claims 5, 10-12, 32, 35, and 37-39 are amended in this communication.

5 1- 4 (Canceled).

5 5 (Currently amended) An electronic device housing comprising:
 a pair of sidewall components extending between respective top
sidewall portions and bottom sidewall portions, the bottom sidewall portions
10 lying in a plane that extends between the bottom sidewall portions; and,
 a bottom component joined with and extending between the bottom
sidewall portions, wherein the bottom component has a non-loaded
disposition relative to the plane and a loaded disposition relative to the plane,
and wherein at least a portion of the bottom component is closer to the plane
15 in the loaded disposition than in the non-loaded disposition, wherein the
portion of the bottom component is juxtaposed with one or more manipulated
regions of the bottom component such that the manipulated regions urge the
[[first]] portion away from the plane while the bottom component retains a
generally flat profile.

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6 (Original) The electronic device housing as recited in claim 5,
 wherein in the non-loaded disposition and in the loaded disposition, at

least a majority of the bottom component lies on the same side of the plane.

7 (Original) The electronic device housing as recited in claim 5,
5 wherein in the loaded disposition at least a majority of the bottom component is on the same side of the plane as the top portions.

8 (Original) The electronic device housing as recited in claim 5,
wherein the bottom component and the pair of sidewall components are
10 formed from a single piece of material.

9 (Original) The electronic device housing as recited in claim 8,
wherein the single piece of material comprises a base pan.

15 10 (Currently amended) The electronic device housing as recited in claim 5, wherein the portion of the bottom component is generally oriented along a the length of the bottom component from a front edge but not completely to a back edge.

20 11 (Currently amended) The electronic device housing as recited in claim 5, wherein the portion of the bottom component extends along an entirety of a the length of the bottom component from a front edge to a back edge.[[.]]

12 (Currently amended) The electronic device housing as recited in
claim 5, wherein the portion of the bottom component is generally
oriented along a the width of the bottom component between the bottom
5 sidewall portions.

13-30 (Canceled).

31. (Previously presented) The electronic device housing as
10 recited in claim 5, wherein the manipulated regions form shallow bends on
each side of the portion.

32 (Currently amended) The electronic device housing as
recited in claim 31, wherein the manipulated regions form bends having a
15 an angle in the range of about 180.2 degrees to about 185 degrees.

33 (Previously presented) The electronic device housing as
recited in claim 5, wherein the manipulated regions form a gradual arch
across the portion.

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34 (Previously presented) The electronic device housing as
recited in claim 12 wherein the manipulated regions result in a portion that
is a v-shaped portion.

35 (Currently amended) The electronic device housing as
recited in claim 5, wherein the bottom component has a width between the
bottom sidewall components in the range of 15 inches to about 20 inches and
5 wherein the non-loaded disposition relative to the plane is in the range of
0.002 to 0.020 inches.

36 (Previously presented) The electronic device housing as
recited in claim 5, wherein the bottom component has a width between the
10 bottom sidewall components in the range of 15 inches to about 20 inches and
wherein the non-loaded disposition relative to the plane is in the range of
0.001 to 0.300 inches.

37 (Currently amended) The electronic device housing as
15 recited in claim 5, wherein the portion comprises a first portion and wherein a
second portion of the bottom component juxtaposed the sidewall component
forms an angle of less than 90 degrees relative to the sidewall component.

38 (Currently amended) The electronic device housing as
20 recited in claim 8, wherein the portion comprises a first portion, wherein prior
to attaching a top component, a second portion of the bottom component
juxtaposed the sidewall component forms an angle of about 88 degrees
relative to the sidewall component.

39 (Currently amended) The electronic device housing as
recited in claim 8, wherein the portion comprises a first portion, wherein prior
to attaching a top component, a second portion of the bottom component
5 juxtaposed the sidewall component forms an angle in the range of about 80
degrees to about 89.5 degrees relative to the sidewall component.

40 (Previously presented) The electronic device housing as
recited in claim 5, further comprising a top component joined to the
10 respective sidewall portions, wherein the bottom component has a generally
concave shape that is oriented away from the top component.

41 (Previously presented) The electronic device housing as
recited in claim 40, wherein the concave shape of the bottom component lies
15 on the same side of the plane as the top component.

42 (Previously presented) The electronic device housing as
recited in claim 5, further comprising electronic components mounted to the
bottom component to produce the loaded disposition.

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